



#### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
Q1	30V	$20m\Omega @ V_{GS} = 10V$	8A
QI	300	$32m\Omega @ V_{GS} = 4.5V$	6.3A
Q2	201/	11.1m $\Omega$ @ V <sub>GS</sub> = 10V	10.7A
QZ	30V	13.8mΩ @ $V_{GS}$ = 4.5V	9.6A

### Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

### Applications

- Mobile Computing
- Point of Load

#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

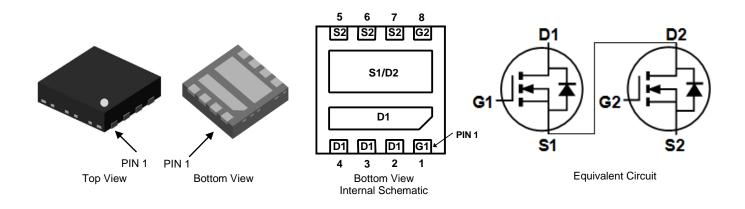
#### Features

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low Gate Threshold Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: V-DFN3030-8 (Type K)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.02 grams (Approximate)

V-DFN3030-8 (Type K)



### Ordering Information (Note 4)

Notes:

Part Number	Case	Packaging
DMT3011LDT-7	V-DFN3030-8 (Type K)	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

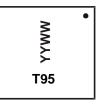
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



# **Marking Information**



T95 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 14 for 2014) WW = Week Code (01 to 53)

#### **Maximum Ratings** (Q1 N-Channel) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	30	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 5) $V_{GS}$ = 10V	I <sub>D</sub>	8 21.5	A
Maximum Body Diode Forward Current (Note 5)	Is	2	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	55	A
Avalanche Current (L = 0.1mH)	I <sub>AS</sub>	14	A
Avalanche Energy (L = 0.1mH)	Eas	9.8	mJ

#### Maximum Ratings (Q2 N-Channel) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	30	V		
Gate-Source Voltage	V <sub>GSS</sub>	+20 -16	V		
Continuous Drain Current (Note 5) $V_{GS}$ = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>C</sub> = +25°C	I <sub>D</sub>	10.7 28.9	А
Maximum Body Diode Forward Current (Note 5)	I <sub>S</sub>	2	А		
Pulsed Drain Current (10µs Pulse, Duty cycle = 1%)	I <sub>DM</sub>	80	A		
Avalanche Current (L = 0.1mH)	I <sub>AS</sub>	18	A		
Avalanche Energy (L = 0.1mH)			E <sub>AS</sub>	16.2	mJ

#### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>θJA</sub>	65	°C/W
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	1.9	W
Thermal Resistance, Junction to Case (Note 5)	Steady State	R <sub>eJC</sub>	9	°C/W
Total Power Dissipation (Note 5)	T <sub>C</sub> = +25°C	PD	13.9	W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.



# Electrical Characteristics (Q1 N-Channel) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)		1	1	1		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30		—	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	1	μA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	Igss	—	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	-	3	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
Static Drain-Source On-Resistance		—	-	20	mΩ	$V_{GS} = 10V, I_D = 6A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	—	32	11122	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5A
Diode Forward Voltage	V <sub>SD</sub>	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 6A$
DYNAMIC CHARACTERISTICS (Note 7)			•			÷
Input Capacitance	Ciss	—	641	—	pF	
Output Capacitance	Coss	—	66	—	pF	− V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, − f = 1MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	—	50	—	pF	
Gate Resistance	Rg	_	2.2	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	—	13.2	—	nC	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	—	6	—	nC	
Gate-Source Charge	Q <sub>gs</sub>	_	1.7	—	nC	$V_{DS} = 15V, I_D = 10A$
Gate-Drain Charge	Q <sub>gd</sub>	—	2.2	—	nC	7
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.3	_	nS	
Turn-On Rise Time	t <sub>R</sub>	—	4.4	—	nS	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 15V,
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	22.3	—	nS	$R_G = 6\Omega, I_D = 1A$
Turn-Off Fall Time	t <sub>F</sub>	_	5.3	_	nS	7
Reverse Recovery Time	t <sub>RR</sub>	—	11.4	—	nS	
Reverse Recovery Charge	Q <sub>RR</sub>	—	8.2	—	nC	I <sub>F</sub> = 11A, di/dt = 100A/µs

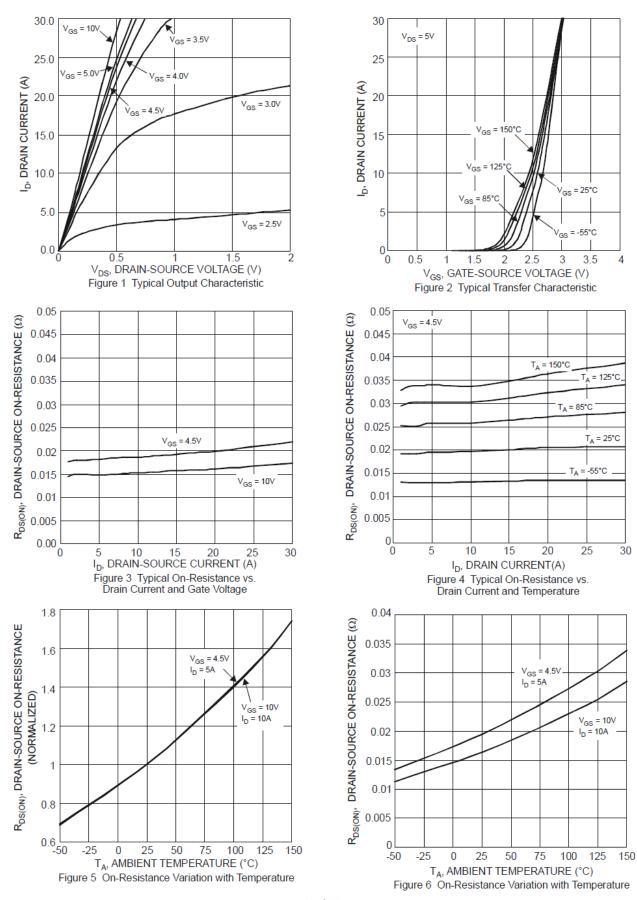
# Electrical Characteristics (Q2 N-Channel) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

		-			-	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)			-			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		_	-1	μA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	IGSS		—	±100	nA	$V_{GS} = +20V, V_{DS} = 0V$ $V_{GS} = -16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
Static Drain-Source On-Resistance		_		11.1	mΩ	$V_{GS} = 10V, I_{D} = 9A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	—	13.8	11122	$V_{GS} = 4.5V, I_D = 7A$
Diode Forward Voltage	V <sub>SD</sub>	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 9A$
DYNAMIC CHARACTERISTICS (Note 7)						·
Input Capacitance	Ciss	—	748	—	pF	
Output Capacitance	Coss	_	447	—	pF	− V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, − f = 1MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	43	—	pF	
Gate Resistance	Rg	_	1.0	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qq	—	13.8	—	nC	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	6.4	—	nC	ר - Vps = 15V. lp = 14.4A
Gate-Source Charge	Q <sub>gs</sub>	—	2.2	—	nC	$v_{DS} = 15v, I_D = 14.4A$
Gate-Drain Charge	Q <sub>gd</sub>	_	2.2	—	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	—	3.5	—	ns	
Turn-On Rise Time	t <sub>R</sub>	_	5.0	—	ns	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 15V,
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	8.6	_	ns	$R_G = 1\Omega$ , $I_D = 10A$
Turn-Off Fall Time	t <sub>F</sub>		1.4	—	ns	7
Reverse Recovery Time	t <sub>RR</sub>		18	—	ns	
Reverse Recovery Charge	Q <sub>RR</sub>		7.7	—	nC	I <sub>F</sub> = 10A, di/dt = 100A/μs

Notes: 6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.

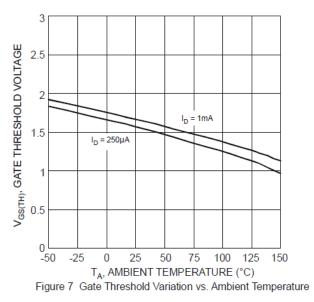


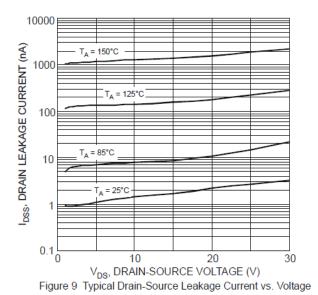
#### Typical Characteristics (Q1 N-Channel)

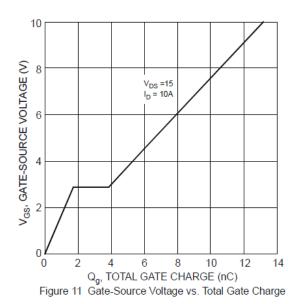


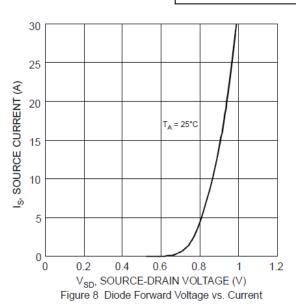


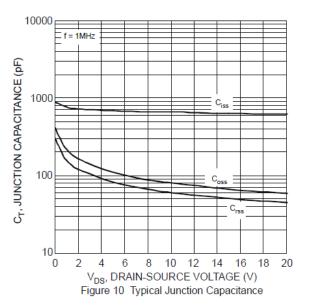
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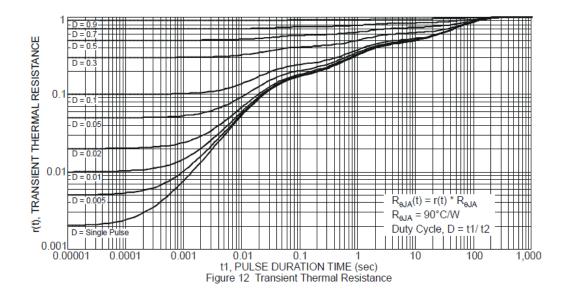






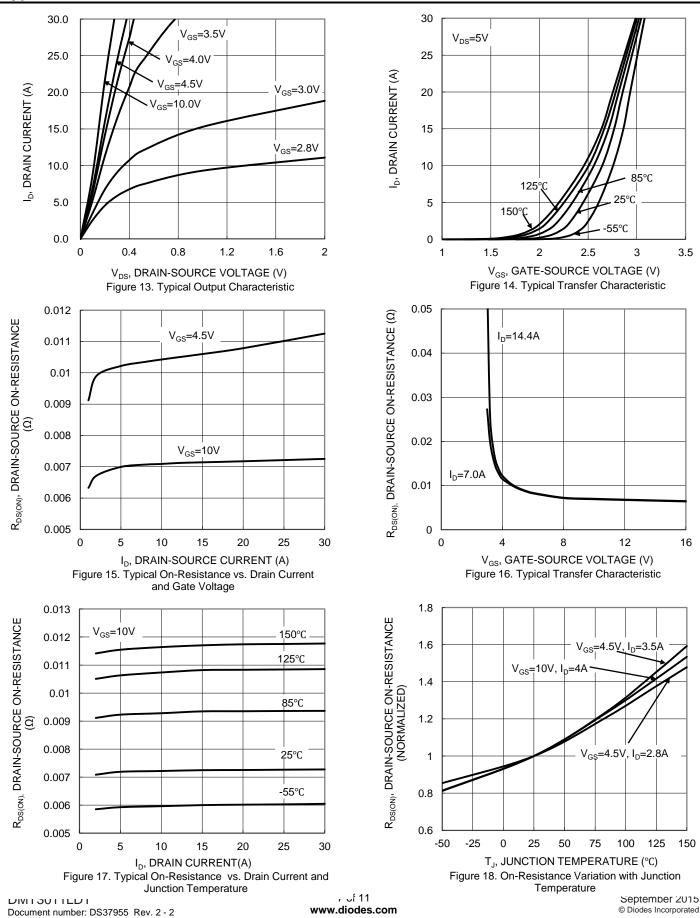






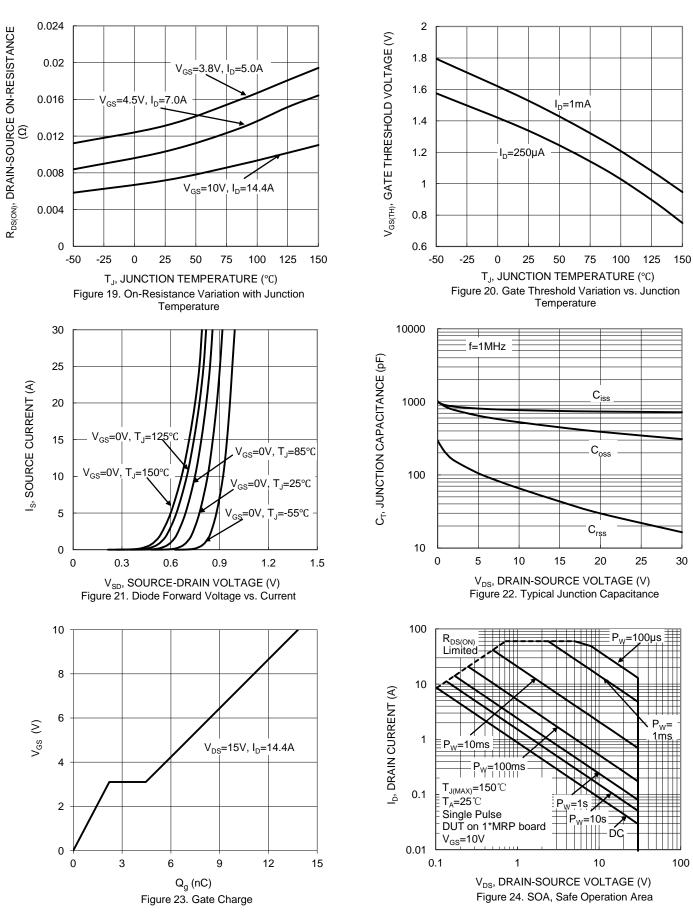


# Typical Characteristics (Q2 N-Channel)





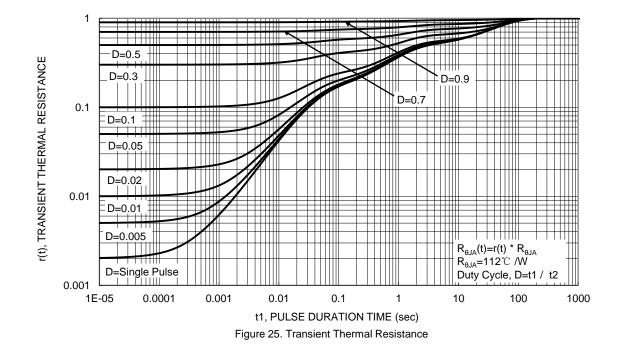
### DMT3011LDT



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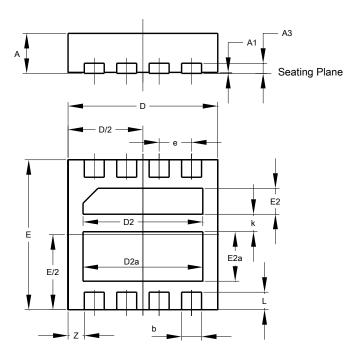






### **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



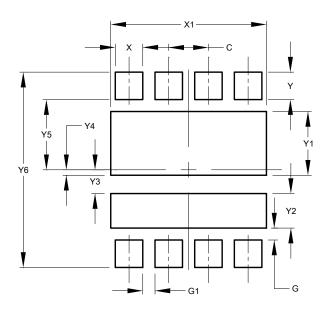
V-DFN3030-8 (Type K)
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V DEN2020 8						
V-DFN3030-8 (Type K)						
Dim	Min	Max	Тур			
Α	0.77	0.85	0.80			
A1	0	0.05	0.02			
A3	0.20BSC					
b	0.35	0.45	0.40			
D	2.95	3.050	3.00			
D2	2.30	2.50	2.40			
D2a	2.30	2.50	2.40			
Е	2.95	3.050	3.00			
E2	0.42	0.62	0.52			
E2a	0.89	1.09	0.99			
е	(	0.65BSC				
k	-	-	0.35			
L	0.30	0.40	0.35			
z	0	0.325BSC				
All	Dimensi	ions in	mm			

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

#### V-DFN3030-8 (Type K)



Dimensions	Value (in mm)
С	0.650
G	0.195
G1	0.200
Х	0.450
X1	2.550
Y	0.450
Y1	1.044
Y2	0.566
Y3	0.389
Y4	0.089
Y5	1.150
Y6	3.200



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